

Docket Number: 1601457-0007

## **DECLARATION FOR PATENT APPLICATION**

As a below named inventor, I hereby declare that:

My residence, post o	ffice address and c	citizenship are as stated belo	w next to my name.
original, first and join	nt inventor (if plura	e inventor (if only one name al names are listed below) o nt on the invention entitled	e is listed below) or an f the subject matter which is
the specification of v	which is attached h	nereto unless the following b	oox is checked:
	l Application Num	as United States Application	
		understand the contents of t mended by any amendment	
I acknowledge the du 37 CFR § 1.56.	ity to disclose info	rmation which is material to	patentability as defined in
application(s) for pat application which de have also identified b	ent or inventor's cosignated at least or below, by checking PCT international	ertificate, or § 365(a) of any ne country other than the Ur the box, any foreign application having a filing of	nited States, listed below and cation for patent or inventor's
Prior Foreign Applica	ation(s)		Priority Is Claimed
PCT/SG01/00134_	Singapore	28 /6 /2001	X
Number	Country	Day/Month/Year Filed	<del> </del>
Number	Country	Day/Month/Year Filed	
I hereby claim the be application(s) listed b		S.C. § 119(e) of any United S	States provisional
(Application Number	r)		(Filing Date)
			ates application(s), or § 365(c)

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or § 365(c) of any PCT international application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT international application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in

37 CFR  $\S$  1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

(Application Number)	(Filing Date)	(Status-	-patented, per	nding, aba	andoned)
(Application Number)	(Filing	g Date)	(Statusp	atented, p	pending, abandoned)
I/we hereby appoint <b>Practi</b> agent(s) to prosecute the apstates Patent and Trademan	oplication identifi	ed above, a	and to transac	•	
Address all correspondence			_	Facsimile	No.: 212-354-8113
I hereby declare that all statestatements made on inform were made with the knowled fine or imprisonment, or be such willful false statements thereon.	ation and belief a edge that willful f th, under Section	re believe t false statem n 1001 of T	to be true; and the little 18 of the	d further the like so may United S	that these statement ade are punishable b states Code and that
Full name of sole or first in	150	e, middle ir	nitial, last nar	ŕ	ng Pin Poo 30 - 7 - 2001
Residence: <u>Apt Blk 44, Bec</u> Citizenship: <u>Malaysian, Sir</u>	dok South Road,			0044, Sin	<u>igapore</u>
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X Additional inventors	are named on th	ne page(s) a	ittached heret	to.	

Full name of second inventor (first name, middle initial, last name): Lay Chuan Lim								
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